

NOTES:

1) MATERIAL:

HOUSING: GLASS FILLED NYLON, UL94V-0, COLOR: BLACK
INSULATOR: GLASS FILLED NYLON, UL94V-0, COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE: .012/ 0.30 THICK

2) FINISH:

TERMINALS:

SELECT GOLD IN CONTACT AREA: 50 MICROINCHES/ 1.27 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES/ 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES/ 1.27 MICROMETERS MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAIL AREA.

3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43223-001.

4) PACKAGING SPECIFICATION:

UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN TRAYS PER MOLEX
PACKAGING SPECIFICATION PK-43249-004.

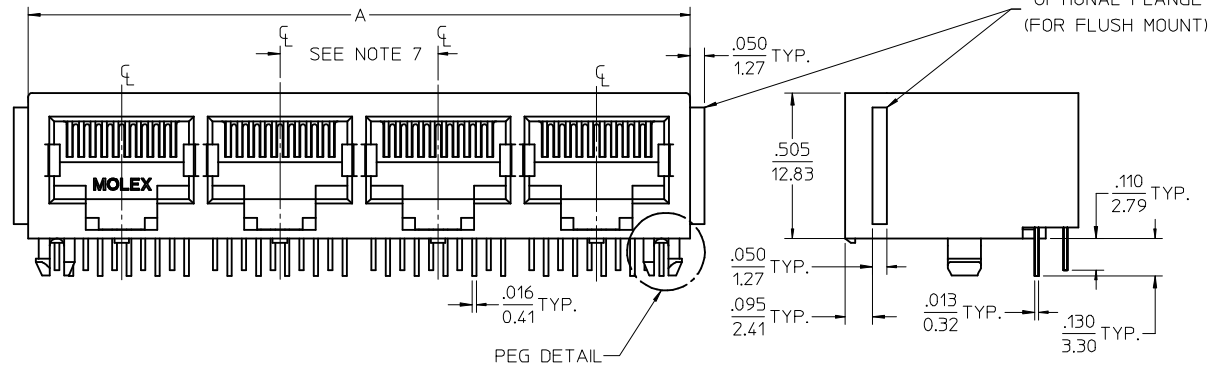
5) SEE SHEETS 4-6 FOR P.C. BOARD LAYOUTS.

6) SEE SHEET 2 FOR THE SHIELDED JACK ASSEMBLY.

7) FOR 6 CIRCUIT JACKS CENTERLINE TO CENTERLINE SPACING IS .448/ 11.38, FOR 8 CIRCUIT JACKS CENTERLINE TO CENTERLINE SPACING IS .550/ 13.97.

8) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.

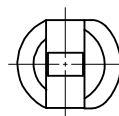
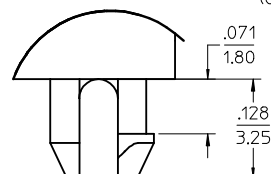
9) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002.



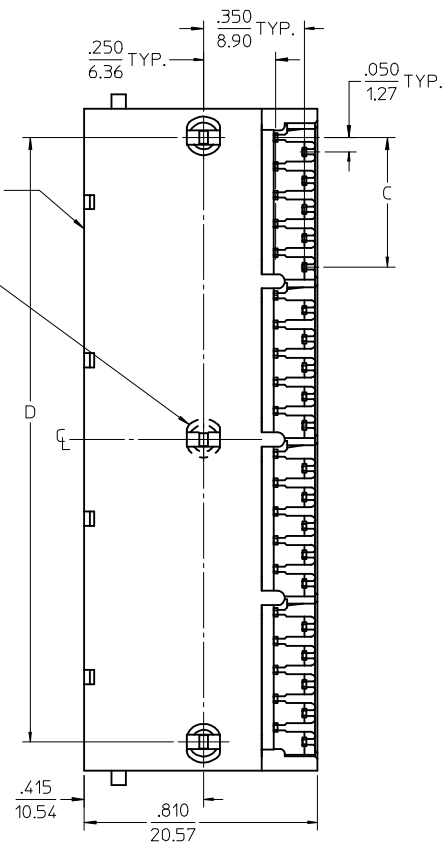
4 PORT 8 LOADED
10 JACK SHOWN

UNSHIELDED GANGED JACK ASSEMBLY
SEE SHEET 3

CENTER PEG
(8 PORT ASSY. ONLY)



SNAP-FIT
PEG DETAIL
SCALE 8:1



6 CIRCUIT HOUSING

CIRCUIT SIZE	NO. OF PORTS	DIM. A	DIM. C	DIM. D
6	2	.985 (25.02)	.250 (6.35)	.848 (21.54)
4	2	.985 (25.02)	.150 (3.81)	.848 (21.54)
2	2	.985 (25.02)	.050 (1.27)	.848 (21.54)
6	3	1.433 (36.40)	.250 (6.35)	1.296 (32.92)
4	3	1.433 (36.40)	.150 (3.81)	1.296 (32.92)
2	3	1.433 (36.40)	.050 (1.27)	1.296 (32.92)
6	4	1.881 (47.78)	.250 (6.35)	1.744 (44.30)
4	4	1.881 (47.78)	.150 (3.81)	1.744 (44.30)
2	4	1.881 (47.78)	.050 (1.27)	1.744 (44.30)
6	5	2.329 (59.16)	.250 (6.35)	2.192 (55.68)
4	5	2.329 (59.16)	.150 (3.81)	2.192 (55.68)
2	5	2.329 (59.16)	.050 (1.27)	2.192 (55.68)
6	6	2.777 (70.54)	.250 (6.35)	2.640 (67.06)
4	6	2.777 (70.54)	.150 (3.81)	2.640 (67.06)
2	6	2.777 (70.54)	.050 (1.27)	2.640 (67.06)
6	8	3.673 (93.29)	.250 (6.35)	3.536 (89.81)
4	8	3.673 (93.29)	.150 (3.81)	3.536 (89.81)
2	8	3.673 (93.29)	.050 (1.27)	3.536 (89.81)

8 CIRCUIT HOUSING

CIRCUIT SIZE	NO. OF PORTS	DIM. A	DIM. C	DIM. D
10	2	1.200 (30.48)	.450 (11.43)	1.000 (25.40)
8	2	1.200 (30.48)	.350 (8.89)	1.000 (25.40)
6	2	1.200 (30.48)	.250 (6.35)	1.000 (25.40)
10	3	1.750 (44.45)	.450 (11.43)	1.550 (39.37)
8	3	1.750 (44.45)	.350 (8.89)	1.550 (39.37)
6	3	1.750 (44.45)	.250 (6.35)	1.550 (39.37)
4	3	1.750 (44.45)	.150 (3.81)	1.550 (39.37)
10	4	2.300 (58.42)	.450 (11.43)	2.100 (53.34)
8	4	2.300 (58.42)	.350 (8.89)	2.100 (53.34)
4	4	2.300 (58.42)	.150 (3.81)	2.100 (53.34)
4	5	2.850 (72.39)	.150 (3.81)	2.650 (67.31)
10	5	2.850 (72.39)	.450 (11.43)	2.650 (67.31)
8	5	2.850 (72.39)	.350 (8.89)	2.650 (67.31)
10	6	3.400 (86.36)	.450 (11.43)	3.200 (81.28)
8	6	3.400 (86.36)	.350 (8.89)	3.200 (81.28)
10	8	4.500 (114.30)	.450 (11.43)	4.300 (109.22)
8	8	4.500 (114.30)	.350 (8.89)	4.300 (109.22)

ADD BLOCK TOL
EC NO: UCP2009-0477
DRWN: BELL
CHKD: BELL
APPR: FSMITH

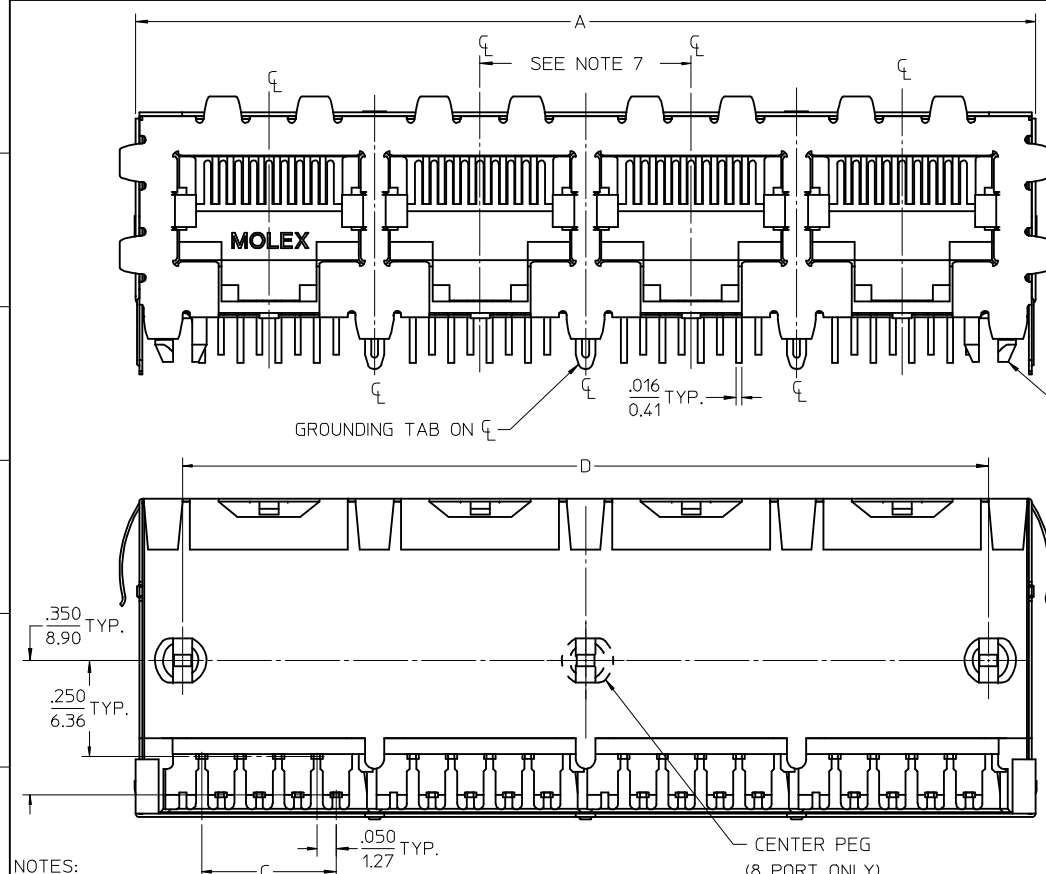
2008/09/05
2008/09/11
2008/09/11

QUALITY SYMBOLS
▽=0
▽=0

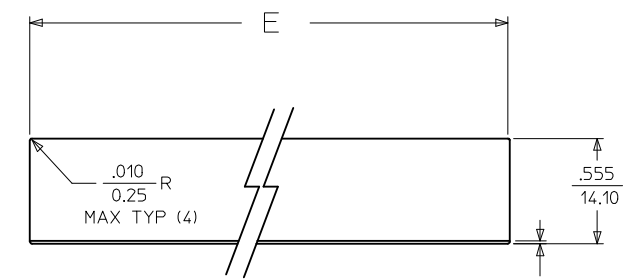
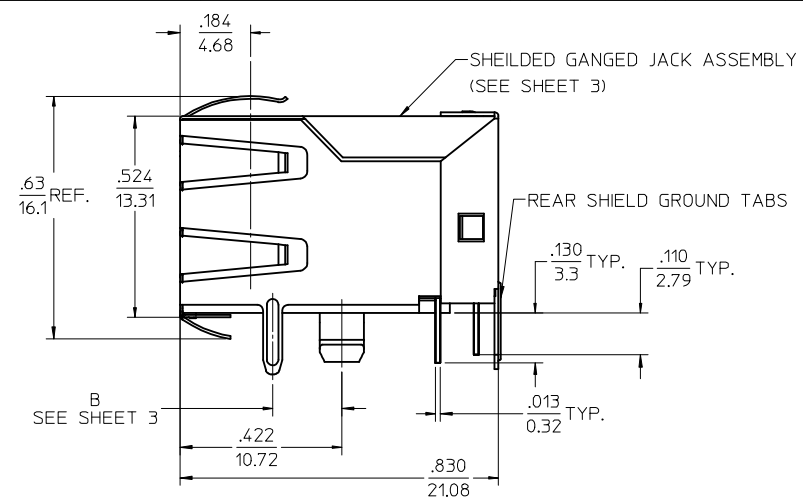
GENERAL TOLERANCES (UNLESS SPECIFIED)
mm INCH
4 PLACES ± --- ± ---
3 PLACES ± --- ± .015
2 PLACES ± 0.38 ± ---
1 PLACE ± --- ± ---
ANGULAR ± 1/2°
DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE
IN/MM
DRAWN BY DATE
JTR 1993/10/18
CHECKED BY DATE
JTR 1993/10/18
APPROVED BY DATE
RAS 1993/10/18
MATERIAL NO.
SEE SHTS 3
SIZE C

SCALE
3:1
DESIGN UNITS
INCH
THIRD ANGLE PROJECTION
LOW PROFILE GANGED,
RIGHT ANGLE MODULAR JACK
ASSEMBLY
MOLEX INCORPORATED
DOCUMENT NO.
SDA-43223
SHEET NO.
1 OF 6
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX
INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

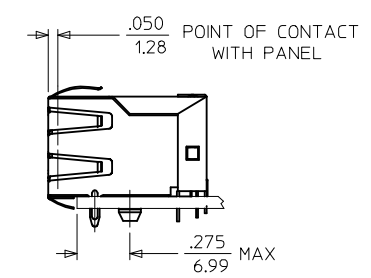


- NOTES:
- 1) MATERIAL:
HOUSING: GLASS FILLED NYLON, UL94V-0, COLOR: BLACK
INSULATOR: GLASS FILLED NYLON, UL94V-0, COLOR: BLACK
TERMINALS: PHOSPHOR BRONZE: .012/ 0.30 THICK
SHIELD: BRASS, FRONT .007/ 0.18 THICK, REAR .010/ 0.25 THICK
 - 2) FINISH:
TERMINALS:
SELECT GOLD IN CONTACT AREA: 50 MICROINCHES/ 1.27 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES/ 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES/ 1.27 MICROMETERS MIN.
SHIELD:
*100 MICROINCHES/ 2.54 MICROMETERS NICKEL OVER 50 MICROINCHES/ 1.27 MICROMETERS COPPER UNDERPLATE. PCB GROUND TABS DIPPED IN TIN
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC". CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD IN THE PC TAIL AND/OR SHIELD.
 - 3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43223-001.
 - 4) PACKAGING SPECIFICATION:
SHIELDED CONNECTOR ASSEMBLIES PACKAGED IN TRAYS PER MOLEX PACKAGING SPECIFICATION PK-44150-004.
 - 5) SEE SHEETS 4-6 FOR P.C. BOARD LAYOUTS.
 - 6) REAR SHIELD IS AVAILABLE WITH (1) CENTERED GROUND TAB ON 4 & 8 PORT VERSIONS.
 - 7) 8 CIRCUIT JACKS CENTERLINE TO CENTERLINE SPACING IS .550/ 13.97.
 - 8) ALL UNTOLERANCED DIMENSIONS ARE SHOWN FOR REFERENCE ONLY.
 - 9) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002.



SUGGESTED PANEL OPENING

SCALE : 2/1

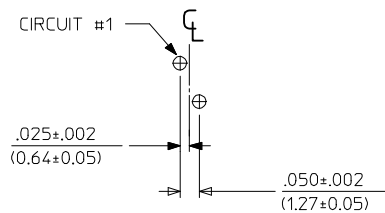


4 PORT 8 LOADED
8 JACK SHOWN

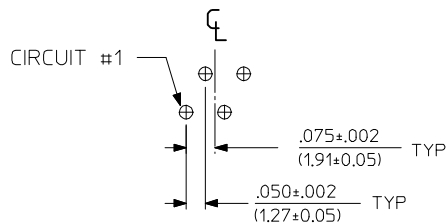
HOUSING SIZE	CIRCUIT SIZE	NO. OF PORTS	DIM. A	DIM. C	DIM. D	DIM. E
8	8	2	1.224 (31.09)	.350 (8.89)	1.000 (25.40)	1.255 (31.88)
8	8	4	2.324 (59.03)	.350 (8.89)	2.100 (53.34)	2.355 (59.82)
8	8	6	3.424 (86.97)	.350 (8.89)	3.200 (81.28)	3.455 (87.76)
8	8	8	4.524 (114.91)	.350 (8.89)	4.300 (109.22)	4.555 (115.97)
8	2	8	4.524 (114.91)	.050 (1.27)	4.300 (109.22)	4.555 (115.97)

SEE SHEET 1 EC NO: UCP2009-0477 DRWN:JBELL CHKD:JBELL APPR:FSM/TH 2008/09/05 2008/09/11 2008/09/11	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION	
		mm INCH		DRAWN BY JTR	DATE 1993/10/18	LOW PROFILE GANGED, RIGHT ANGLE MODULAR JACK ASSEMBLY MOLEX INCORPORATED			
		4 PLACES ± --- ± --- 3 PLACES ± --- ± .015 2 PLACES ± 0.38 ± --- 1 PLACE ± --- ± ---		CHECKED BY JTR	DATE 1993/10/18				
		ANGULAR ± 1/2°		APPROVED BY RAS	DATE 1993/10/18				
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO. SEE SHTS 3		DOCUMENT NO. SDA-43223		SHEET NO. 2 OF 6			
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									

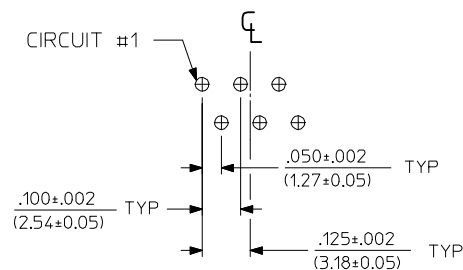
	13	12	11	10	9	8	7	6	5	4	3	2	1			
J	FLUSH MOUNT (UNSHIELDED)						FLANGELESS (UNSHIELDED)						J			
	ASSEMBLY NUMBER	CONNECTOR SIZE	NUMBER OF CIRCUITS	NUMBER OF PORTS	PACKAGING STYLE	PACKAGING SPECIFICATION	ASSEMBLY NUMBER	CONNECTOR SIZE	NUMBER OF CIRCUITS	NUMBER OF PORTS	PACKAGING STYLE	PACKAGING SPECIFICATION				
	43223-6001	6	6	2	TRAY	PK-43249-004	43223-6101	6	6	2	TRAY	PK-43249-004				
I	43223-6004	6	6	3	↑	↑	43223-6104	6	6	3	↑	↑				
	43223-6007	6	6	4			43223-6107	6	6	4						
	43223-6010	6	6	5			43223-6110	6	6	5						
	43223-6013	6	6	6			43223-6113	6	6	6						
	43223-6019	6	6	8			43223-6119	6	6	8						
	43223-6022	6	4	2			43223-6122	6	4	2						
	43223-6025	6	4	3			43223-6125	6	4	3						
	43223-6028	6	4	4			43223-6128	6	4	4						
	43223-6031	6	4	5			43223-6131	6	4	5						
	43223-6034	6	4	6			43223-6134	6	4	6						
	43223-6040	6	4	8			43223-6140	6	4	8						
	43223-6043	6	2	2			43223-6143	6	2	2						
H	43223-6046	6	2	3			43223-6146	6	2	3						
	43223-6049	6	2	4			43223-6149	6	2	4						
	43223-6052	6	2	5			43223-6152	6	2	5						
	43223-6055	6	2	6	↓	↓	43223-6155	6	2	6	↓	↓				
	43223-6058	6	2	8	TRAY	PK-43249-004	43223-6158	6	2	8	TRAY	PK-43249-004				
	43223-8001	8	10	2	TRAY	PK-43249-004	43223-8101	8	10	2	TRAY	PK-43249-004				
	43223-8004	8	10	3	↑	↑	43223-8104	8	10	3	↑	↑				
G	43223-8007	8	10	4			43223-8107	8	10	4						
	43223-8010	8	10	5			43223-8110	8	10	5						
	43223-8013	8	10	6			43223-8113	8	10	6						
	43223-8019	8	10	8			43223-8119	8	10	8						
	43223-8022	8	8	2			43223-8122	8	8	2						
	43223-8025	8	8	3			43223-8131	8	8	3						
	43223-8028	8	8	4			43223-8140	8	8	4						
	43223-8031	8	8	5			43223-8149	8	8	5						
	43223-8034	8	8	6			43223-8158	8	8	6	↓	↓				
	43223-8040	8	8	8			43223-8176	8	8	8	TRAY	PK-43249-004				
	43223-8041	8	4	5	↓	↓										
	43223-8042	8	6	3	TRAY	PK-43249-004										
F																
E	FLANGELESS (SHIELDED)								SNAP FIT PEG VERSIONS				E			
	ASSEMBLY NUMBER	DIMENSION "B"	CONNECTOR SIZE	NUMBER OF CIRCUITS	NUMBER OF PORTS	NUMBER OF REAR SHIELD GROUND TABS	PACKAGING STYLE	PACKAGING SPECIFICATION	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE IN/MM	SCALE 2:1	DESIGN UNITS INCH		THIRD ANGLE PROJECTION		
	43223-8128	.180	8	8	2	1	TRAY	PK-44150-004	4 PLACES ± --- ± ---	mm INCH	DRAWN BY JTR	DATE 1993/10/18		TITLE LOW PROFILE GANGED, RIGHT ANGLE MODULAR JACK ASSEMBLY		
	43223-8146	.180	8	8	4	3	↑	↑	3 PLACES ± --- ±.015	CHECKED BY JTR	DATE 1993/10/18					
	43223-8164	.180	8	8	6	5			2 PLACES ± 0.38 ± ---	APPROVED BY RAS	DATE 1993/10/18					
	43223-8182	.180	8	8	8	7	↓	↓	1 PLACE ± --- ± ---	MATERIAL NO. SEE CHART	DOCUMENT NO. SDA-43223					
	D	43223-8185	.180	8	8	8	1			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS					A	
		43223-8188	.180	8	8	4	1			SIZE C THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						
		43223-8194	.180	8	2	8	7	TRAY	PK-44150-004							
		43223-8301	.145	8	8	2	1	TRAY	PK-44150-004							
		43223-8302	.145	8	8	4	3	↑	↑							
		43223-8303	.145	8	8	6	5									
43223-8304		.145	8	8	8	7										
43223-8305		.145	8	8	8	1										
43223-8306		.145	8	8	4	1	↓	↓								
43223-8307		.145	8	2	8	7	TRAY	PK-44150-004								
C													B			
B													A			
A																
1b_frame_C_P_AM_T Rev. E 2006/04/15																
	12	11	10	9	8	7	6	5	4	3	2	1				



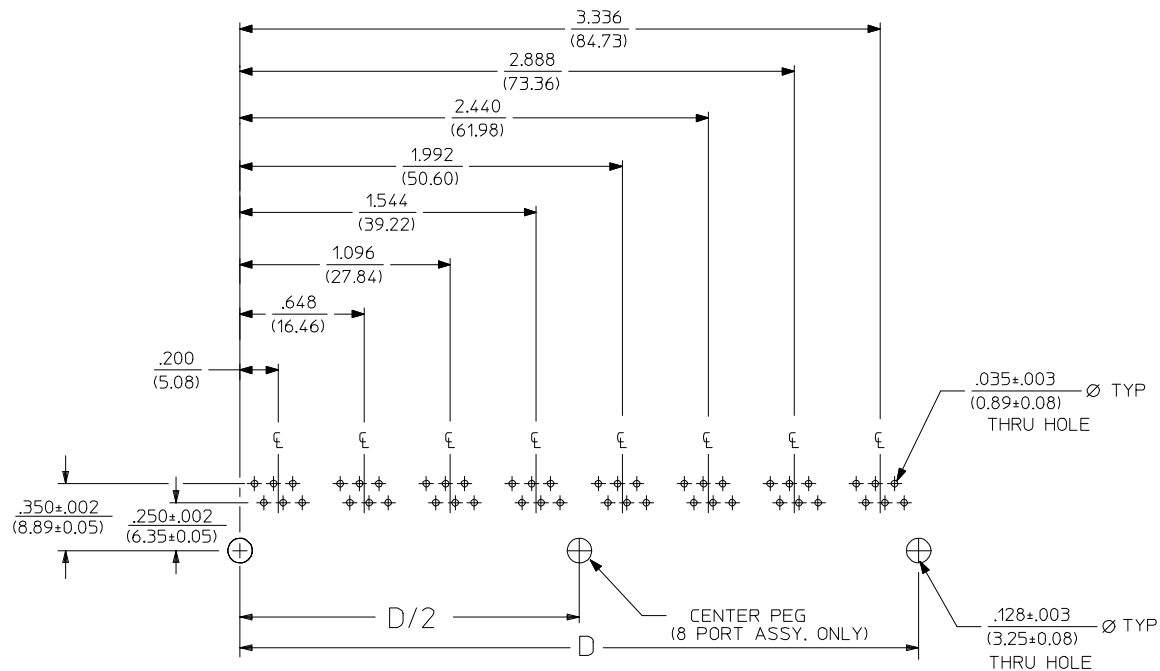
6 LOADED 2 DETAIL
SCALE: 4/1



6 LOADED 4 DETAIL
SCALE: 4/1



6 LOADED 6 DETAIL
SCALE: 4/1

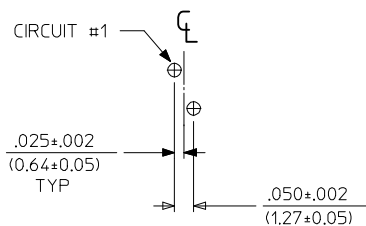


SUGGESTED P.C. BOARD LAYOUT
COMPONENT SIDE OF BOARD
8 PORT, 6 LOADED 6, LAYOUT SHOWN
(SNAP-FIT VERSIONS)

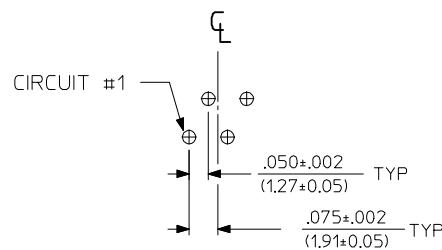
NOTES:
1. RECOMMENDED PCB THICKNESS .062±.005/(1.57±0.13)

NUMBER OF PORTS	DIM. D
2	.848 (21.54)
3	1.296 (32.92)
4	1.744 (44.30)
5	2.192 (55.68)
6	2.640 (67.06)
8	3.536 (89.81)

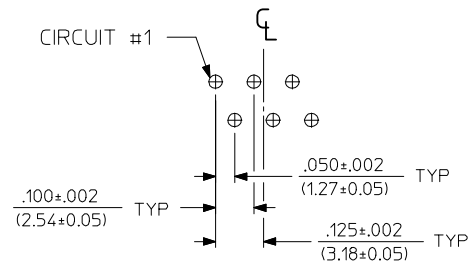
SEE SHEET 1 EC NO: UCP2009-0477 DRWN:JBELL 2008/09/05 CHKD:JBELL 2008/09/11 APPR:FSM TH 2008/09/11 K1	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 2:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION ☉ ☐				
				mm	INCH	DRAWN BY JTR	DATE 1993/10/18	TITLE LOW PROFILE GANGED, RIGHT ANGLE MODULAR JACK ASSEMBLY MOLEX INCORPORATED	MOLEX	SHEET NO. 4 OF 6			
			4 PLACES ± ---	± ---	± ---	CHECKED BY	DATE						
			3 PLACES ± ---	± ---	± .015	JTR	1993/10/18						
			2 PLACES ± 0.38	± ---	± ---	APPROVED BY	DATE						
			1 PLACE ± ---	± ---	± ---	RAS	1993/10/18						
			ANGULAR ±1/2°			MATERIAL NO.		DOCUMENT NO.			SEE SHT 3	SDA-43223	
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SIZE			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
						C							



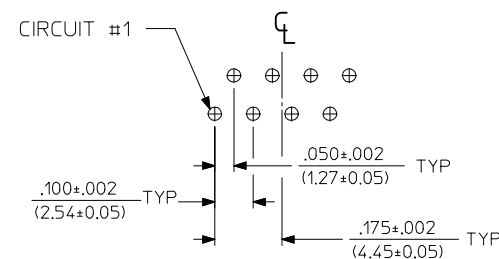
8 LOADED 2 DETAIL
SCALE: 4/1



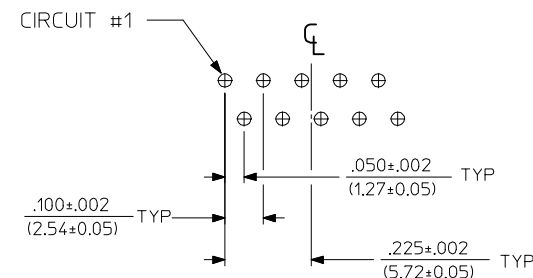
8 LOADED 4 DETAIL
SCALE: 4/1



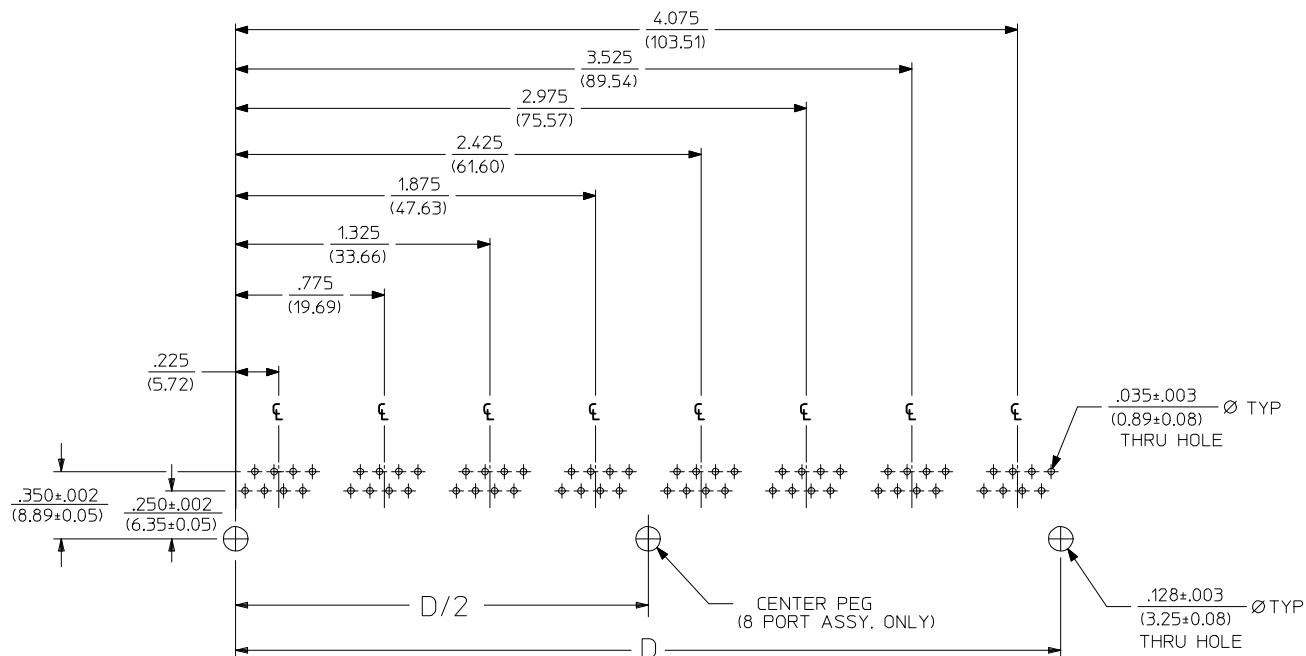
8 LOADED 6 DETAIL
SCALE: 4/1



8 LOADED 8 DETAIL
SCALE: 4/1



8 LOADED 10 DETAIL
SCALE: 4/1



SUGGESTED P.C. BOARD LAYOUT
COMPONENT SIDE OF BOARD
8 PORT, 8 LOADED 8
(SNAP-FIT VERSIONS)

NOTES:
1. RECOMMENDED PCB THICKNESS: .062±.005/(1.57±0.13)

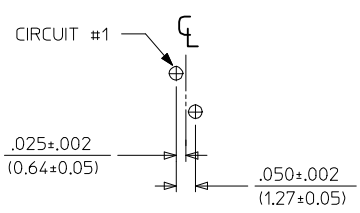
NUMBER OF PORTS	DIM. D
2	1.000 (25.40)
3	1.550 (39.37)
4	2.100 (53.34)
5	2.650 (67.31)
6	3.200 (81.28)
8	4.300 (109.32)

SEE SHEET 1	EC NO: UCP2009-0477	2008/09/05	DRWN:JBELL	2008/09/11	CHKD:JBELL	2008/09/11	APPR:FSM/TH	2008/09/11
K1	REV	DESCRIPTION	QUALITY SYMBOLS	▽=0	▽=0			

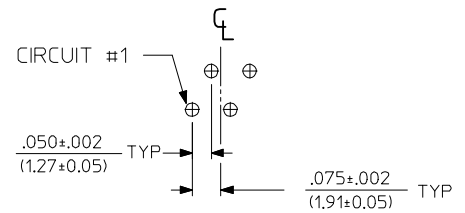
GENERAL TOLERANCES (UNLESS SPECIFIED)	
mm	INCH
4 PLACES ± ---	± ---
3 PLACES ± ---	± .015
2 PLACES ± 0.38	± ---
1 PLACE ± ---	± ---
ANGULAR ± 1/2°	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	

DIMENSION STYLE IN/MM	
DRAWN BY	DATE
JTR	1993/10/18
CHECKED BY	DATE
JTR	1993/10/18
APPROVED BY	DATE
RAS	1993/10/18
MATERIAL NO.	DOCUMENT NO.
SEE SHT 3	SDA-43223
SIZE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION
C	

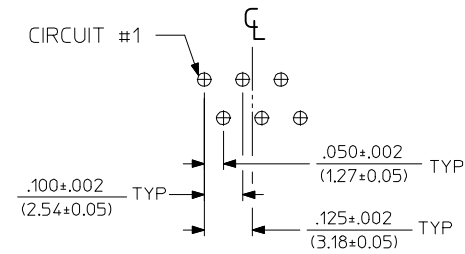
SCALE 2:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION
TITLE		
LOW PROFILE GANGED, RIGHT ANGLE MODULAR JACK ASSEMBLY		
MOLEX INCORPORATED		
SHEET NO. 5 OF 6		



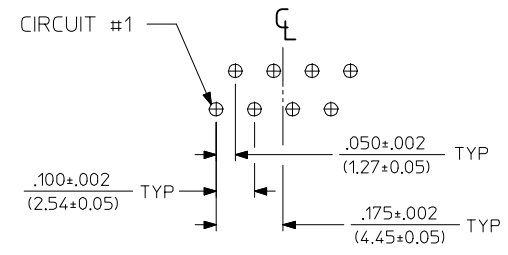
8 LOADED 2 DETAIL
SCALE: 4/1



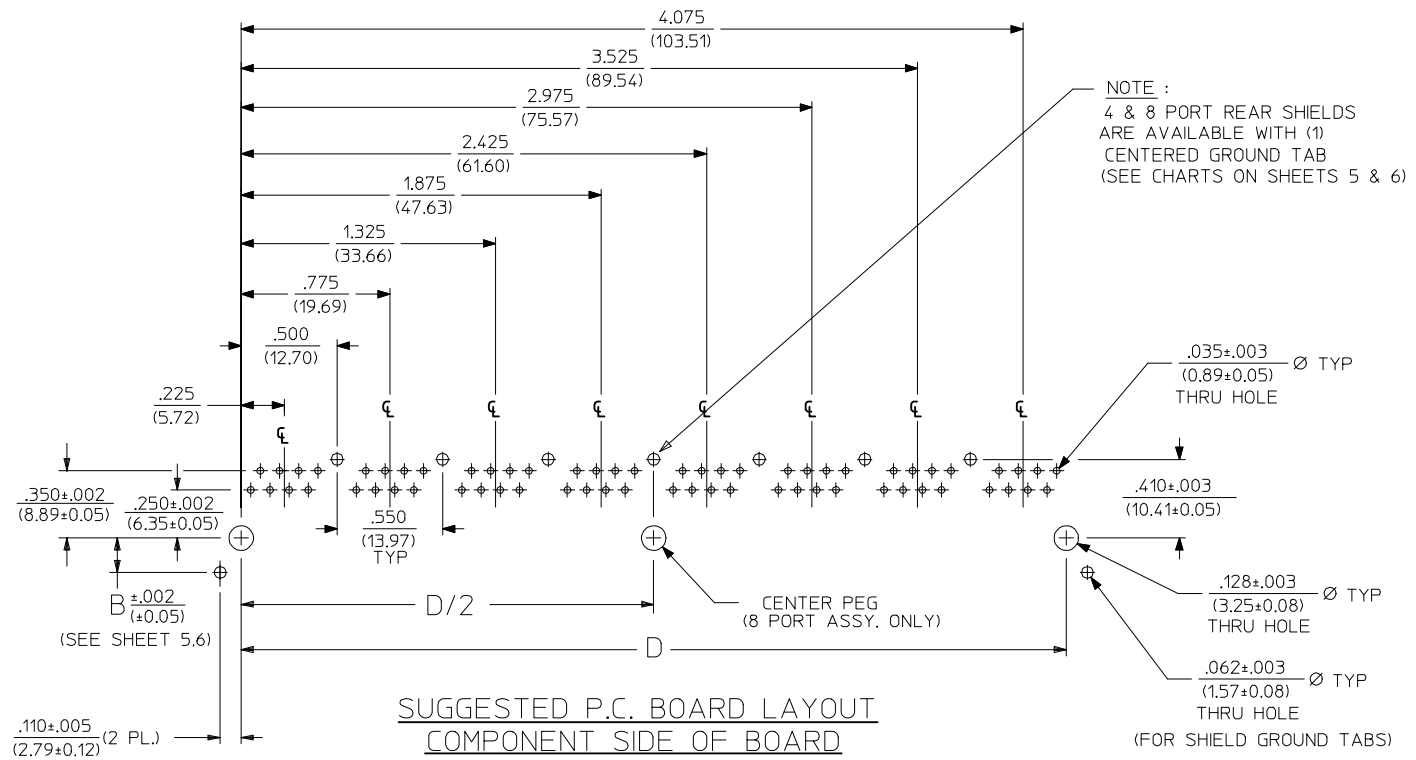
8 LOADED 4 DETAIL
SCALE: 4/1



8 LOADED 6 DETAIL
SCALE: 4/1



8 LOADED 8 DETAIL
SCALE: 4/1



NOTE :
4 & 8 PORT REAR SHIELDS
ARE AVAILABLE WITH (1)
CENTERED GROUND TAB
(SEE CHARTS ON SHEETS 5 & 6)

SUGGESTED P.C. BOARD LAYOUT
COMPONENT SIDE OF BOARD
8 PORT, 8 LOADED 8
(SHIELDED) LAYOUT SHOWN
(SNAP-FIT VERSIONS)

NOTES:
1. RECOMMENDED PCB THICKNESS: .062±.005/(1.57±0.13)

NUMBER OF PORTS	DIM. D
2	1.000 (25.40)
4	2.100 (53.34)
6	3.200 (81.28)
8	4.300 (109.32)

SEE SHEET 1 EC NO: UCP2009-0477 DRWN:JBELL CHKD:JBELL APPR:FSM/TH REV	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
				IN/MM		2:1	INCH	
				DRAWN BY DATE		TITLE		
				CHECKED BY DATE		LOW PROFILE GANGED, RIGHT ANGLE MODULAR JACK ASSEMBLY		
				APPROVED BY DATE		MOLEX INCORPORATED		
		ANGULAR ±1/2°		MATERIAL NO.		DOCUMENT NO.		SHEET NO.
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE SHT 3		SDA-43223		6 OF 6
				THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				

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<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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